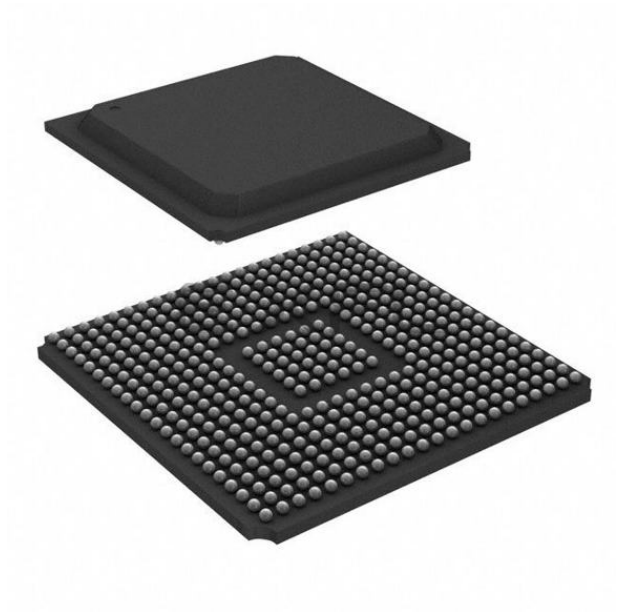

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The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	1280
Number of Logic Elements/Cells	-
Total RAM Bits	737280
Number of I/O	324
Number of Gates	1000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	456-BBGA
Supplier Device Package	456-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v1000-4fg456i

Detailed Description

Input/Output Blocks (IOBs)

Virtex-II™ I/O blocks (IOBs) are provided in groups of two or four on the perimeter of each device. Each IOB can be used as input and/or output for single-ended I/Os. Two IOBs can be used as a differential pair. A differential pair is always connected to the same switch matrix, as shown in Figure 1.

IOB blocks are designed for high performances I/Os, supporting 19 single-ended standards, as well as differential signaling with LVDS, LDT, Bus LVDS, and LVPECL.

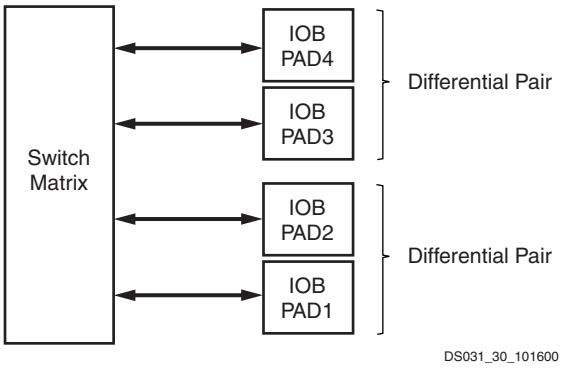

Figure 1: **Virtex-II Input/Output Tile**

Note: Differential I/Os must use the same clock.

Supported I/O Standards

Virtex-II IOB blocks feature SelectI/O-Ultra inputs and outputs that support a wide variety of I/O signaling standards. In addition to the internal supply voltage (V_{CCINT} = 1.5V), output driver supply voltage (V_{CCO}) is dependent on the I/O standard (see Table 1 and Table 2). An auxiliary supply voltage (V_{CCAUX} = 3.3 V) is required, regardless of the I/O standard used. For exact supply voltage absolute maximum ratings, see DC Input and Output Levels in Module 3.

All of the user IOBs have fixed-clamp diodes to V_{CCO} and to ground. As outputs, these IOBs are not compatible or compliant with 5V I/O standards. As inputs, these IOBs are not normally 5V tolerant, but can be used with 5V I/O standards when external current-limiting resistors are used. For more details, see the “5V Tolerant I/Os“ Tech Topic at www.xilinx.com.

Table 3 lists supported I/O standards with Digitally Controlled Impedance. See Digitally Controlled Impedance (DCI), page 8.

Table 1: **Supported Single-Ended I/O Standards**

IOSTANDARD Attribute	Output V_{CCO}	Input V_{CCO}	Input V_{REF}	Board Termination Voltage (V_{TT})
LVTTL	3.3	3.3	N/R(3)	N/R
LVCMOS33	3.3	3.3	N/R	N/R
LVCMOS25	2.5	2.5	N/R	N/R
LVCMOS18	1.8	1.8	N/R	N/R
LVCMOS15	1.5	1.5	N/R	N/R
PCI33_3	3.3	3.3	N/R	N/R
PCI66_3	3.3	3.3	N/R	N/R
PCI-X	3.3	3.3	N/R	N/R
GTL	Note (1)	Note (1)	0.8	1.2
GTLP	Note (1)	Note (1)	1.0	1.5
HSTL_I	1.5	N/R	0.75	0.75
HSTL_II	1.5	N/R	0.75	0.75
HSTL_III	1.5	N/R	0.9	1.5
HSTL_IV	1.5	N/R	0.9	1.5
HSTL_I_18	1.8	N/R	0.9	0.9
HSTL_II_18	1.8	N/R	0.9	0.9
HSTL_III _18	1.8	N/R	1.1	1.8
HSTL_IV_18	1.8	N/R	1.1	1.8
SSTL18_I(2)	1.8	N/R	0.9	0.9
SSTL18_II	1.8	N/R	0.9	0.9
SSTL2_I	2.5	N/R	1.25	1.25
SSTL2_II	2.5	N/R	1.25	1.25
SSTL3_I	3.3	N/R	1.5	1.5
SSTL3_II	3.3	N/R	1.5	1.5
AGP-2X/AGP	3.3	N/R	1.32	N/R

Notes:
1. V_{CCO} of GTL or GTLP should not be lower than the termination voltage or the voltage seen at the I/O pad. Example: If the pin High level is 1.5V, connect V_{CCO} to 1.5V.
2. SSTL18_I is not a JEDEC-supported standard.
3. N/R = no requirement.

Table 5: **Minimum Power On Current Required for Virtex-II Devices**

	Device (mA)							
	XC2V40, XC2V80, XC2V250, XC2V500	XC2V1000	XC2V1500	XC2V2000	XC2V3000	XC2V4000	XC2V6000	XC2V8000
$I_{CCINTMIN}$	200	250	350	400	500	650	800	1100
$I_{CCAUXMIN}$	100	100	100	100	100	100	100	100
I_{CCOMIN}	50	50	100	100	100	100	100	100

Notes:
1. Values specified for power on current parameters are Commercial Grade. For Industrial Grade values, multiply Commercial Grade values by 1.25.
2. I_{CCOMIN} values listed here apply to the entire device (all banks).

General Power Supply Requirements

Proper decoupling of all FPGA power supplies is sessential. Consult Xilinx Application Note **XAPP623** for detailed information on power distribution system design.

V_{CCAUX} powers critical resources in the FPGA. Thus, V_{CCAUX} is especially susceptible to power supply noise.

Changes in V_{CCAUX} voltage outside of 200 mV peak to peak should take place at a rate no faster than 10 mV per millisecond. Techniques to help reduce jitter and period distortion are provided in Xilinx Answer Record 13756, available at **www.support.xilinx.com**.

V_{CCAUX} can share a power plane with 3.3V V_{CCO}, but only if V_{CCO} does not have excessive noise. Using simultaneously switching output (SSO) limits are essential for keeping power supply noise to a minimum. Refer to **XAPP689**, "Managing Ground Bounce in Large FPGAs," to determine the number of simultaneously switching outputs allowed per bank at the package level.

DC Input and Output Levels

Values for V_{IL} and V_{IH} are recommended input voltages. Values for I_{OL} and I_{OH} are guaranteed over the recommended operating conditions at the V_{OL} and V_{OH} test points. Only selected standards are tested. These are chosen to ensure that all standards meet their specifications. The selected standards are tested at minimum V_{CCO} with the respective V_{OL} and V_{OH} voltage levels shown. Other standards are sample tested.

Table 6: **DC Input and Output Levels**

Input/Output	V_{IL}		V_{IH}		V_{OL}	V_{OH}	I_{OL}	I_{OH}
Standard	V, Min	V, Max	V, Min	V, Max	V, Max	V, Min	mA	mA
LVTTL(1)	– 0.5	0.8	2.0	3.6	0.4	2.4	24	– 24
LVCMOS33	– 0.5	0.8	2.0	3.6	0.4	V_{CCO} – 0.4	24	– 24
LVCMOS25	– 0.5	0.7	1.7	2.7	0.4	V_{CCO} – 0.4	24	– 24
LVCMOS18	– 0.5	35% V_{CCO}	65% V_{CCO}	1.95	0.4	V_{CCO} – 0.4	16	– 16
LVCMOS15	– 0.5	35% V_{CCO}	65% V_{CCO}	1.7	0.4	V_{CCO} – 0.4	16	– 16
PCI33_3	– 0.5	30% V_{CCO}	50% V_{CCO}	V_{CCO} + 0.5	10% V_{CCO}	90% V_{CCO}	Note 2	Note 2
PCI66_3	– 0.5	30% V_{CCO}	50% V_{CCO}	V_{CCO} + 0.5	10% V_{CCO}	90% V_{CCO}	Note 2	Note 2
PCI–X	– 0.5	Note 2	Note 2	Note 2	Note 2	Note 2	Note 2	Note 2
GTLP	– 0.5	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.5	0.6	n/a	36	n/a
GTL	– 0.5	V_{REF} – 0.05	V_{REF} + 0.05	V_{CCO} + 0.5	0.4	n/a	40	n/a
HSTL I	– 0.5	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.5	0.4	V_{CCO} – 0.4	8	– 8
HSTL II	– 0.5	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.5	0.4	V_{CCO} – 0.4	16	– 16
HSTL III	– 0.5	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.5	0.4	V_{CCO} – 0.4	24	– 8
HSTL IV	– 0.5	V_{REF} – 0.1	V_{REF} + 0.1	V_{CCO} + 0.5	0.4	V_{CCO} – 0.4	48	– 8

IOB Input Switching Characteristics Standard Adjustments

Table 15 gives all standard-specific data input delay adjustments.

Table 15: **IOB Input Switching Characteristics Standard Adjustments**

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
LVTTL (Low-Voltage Transistor-Transistor Logic)	LVTTL	T_{ILVTTL}	0.00	0.00	0.00	ns
LVCMOS (Low-Voltage CMOS), 3.3V	LVCMOS33	$T_{ILVCMOS33}$	0.00	0.00	0.00	ns
LVCMOS, 2.5V	LVCMOS25	$T_{ILVCMOS25}$	0.11	0.11	0.12	ns
LVCMOS, 1.8V	LVCMOS18	$T_{ILVCMOS18}$	0.42	0.43	0.49	ns
LVCMOS, 1.5V	LVCMOS15	$T_{ILVCMOS15}$	0.98	1.00	1.15	ns
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	T_{ILVDS_25}	0.60	0.60	0.69	ns
LVDS, 3.3V	LVDS_33	T_{ILVDS_33}	0.60	0.60	0.69	ns
LVDSEXT (Extended Mode), 2.5V	LVDSEXT_25	$T_{ILVDSEXT\_25}$	0.68	0.69	0.79	ns
LVDSEXT, 3.3V	LVDSEXT_33	$T_{ILVDSEXT\_33}$	0.56	0.56	0.65	ns
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	T_{IULVDS_25}	0.48	0.49	0.56	ns
BLVDS (Bus LVDS), 2.5V	BLVDS_25	T_{IBLVDS_25}	0.68	0.69	0.79	ns
LDT (HyperTransport), 2.5V	LDT_25	T_{ILDT_25}	0.48	0.49	0.56	ns
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	$T_{ILVPECL\_33}$	0.60	0.60	0.69	ns
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	T_{IPCI33_3}	0.00	0.00	0.00	ns
PCI, 66 MHz, 3.3V	PCI66_3	T_{IPCI66_3}	0.00	0.00	0.00	ns
PCI-X, 133 MHz, 3.3V	PCIX	T_{IPCIX}	0.00	0.00	0.00	ns
GTL (Gunning Transceiver Logic)	GTL	T_{IGTL}	0.42	0.42	0.48	ns
GTL Plus	GTLP	T_{IGTLP}	0.42	0.42	0.48	ns
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	T_{IHSTL_I}	0.42	0.42	0.48	ns
HSTL, Class II	HSTL_II	T_{IHSTL_II}	0.42	0.42	0.48	ns
HSTL, Class III	HSTL_III	T_{IHSTL_III}	0.42	0.42	0.48	ns
HSTL, Class IV	HSTL_IV	T_{IHSTL_IV}	0.42	0.42	0.48	ns
HSTL, Class I, 1.8V	HSTL_I_18	$T_{IHSTL\_I\_18}$	0.42	0.42	0.48	ns
HSTL, Class II, 1.8V	HSTL_II_18	$T_{IHSTL\_II\_18}$	0.42	0.42	0.48	ns
HSTL, Class III, 1.8V	HSTL_III_18	$T_{IHSTL\_III\_18}$	0.42	0.42	0.48	ns
HSTL, Class IV, 1.8V	HSTL_IV_18	$T_{IHSTL\_IV\_18}$	0.42	0.42	0.48	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V	SSTL18_I	$T_{ISSTL18\_I}$	0.42	0.42	0.48	ns
SSTL, Class II, 1.8V	SSTL18_II	$T_{ISSTL18\_II}$	0.42	0.42	0.48	ns
SSTL, Class I, 2.5V	SSTL2_I	T_{ISSTL2_I}	0.42	0.42	0.48	ns
SSTL, Class II, 2.5V	SSTL2_II	T_{ISSTL2_II}	0.42	0.42	0.48	ns
SSTL, Class I, 3.3V	SSTL3_I	T_{ISSTL3_I}	0.35	0.35	0.40	ns
SSTL, Class II, 3.3V	SSTL3_ II	T_{ISSTL3_II}	0.35	0.35	0.40	ns
AGP-2X/AGP (Accelerated Graphics Port)	AGP	T_{IAGP}	0.35	0.35	0.40	ns
LVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V	LVDCI_33	T_{ILVDCI_33}	0.00	0.00	0.00	ns
LVDCI, 2.5V	LVDCI_25	T_{ILVDCI_25}	0.11	0.11	0.12	ns
LVDCI, 1.8V	LVDCI_18	T_{ILVDCI_18}	0.42	0.43	0.49	ns
LVDCI, 1.5V	LVDCI_15	T_{ILVDCI_15}	0.98	1.00	1.14	ns

Table 19: **Output Delay Measurement Methodology**

Description	IOSTANDARD Attribute	R_{REF} (Ω)	C_{REF}[1] (pF)	V_{MEAS} (V)	V_{REF} (V)
SSTL (Stub Series Terminated Logic), Class I, 1.8V	SSTL18_I	50	0	V_{REF}	0.9
SSTL, Class II, 1.8V	SSTL18_II	25	0	V_{REF}	0.9
SSTL, Class I, 2.5V	SSTL2_I	50	0	V_{REF}	1.25
SSTL, Class II, 2.5V	SSTL2_II	25	0	V_{REF}	1.25
SSTL, Class I, 3.3V	SSTL3_I	50	0	V_{REF}	1.5
SSTL, Class II, 3.3V	SSTL3_II	25	0	V_{REF}	1.5
AGP-2X/AGP (Accelerated Graphics Port)	AGP-2X/AGP (rising edge)	50	0	0.94	0
	AGP-2X/AGP (falling edge)	50	0	2.03	3.3
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	50	0	V_{REF}	1.2
LVDS, 3.3V	LVDSEXT_25	50	0	V_{REF}	1.2
LVDSEXT (LVDS Extended Mode), 2.5V	LVDS_33	50	0	V_{REF}	1.2
LVDSEXT, 3.3V	LVDSEXT_33	50	0	V_{REF}	1.2
BLVDS (Bus LVDS), 2.5V	BLVDS_25	1M	0	1.2	0
LDT (HyperTransport), 2.5V	LDT_25	50	0	V_{REF}	0.6
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	1M	0	1.23	0
LVDCI/HSLVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V	LVDCI_33, HSLVDCI_33	1M	0	1.65	0
LVDCI/HSLVDCI, 2.5V	LVDCI_25, HSLVDCI_25	1M	0	1.25	0
LVDCI/HSLVDCI, 1.8V	LVDCI_18, HSLVDCI_18	1M	0	0.9	0
LVDCI/HSLVDCI, 1.5V	LVDCI_15, HSLVDCI_15	1M	0	0.75	0
HSTL (High-Speed Transceiver Logic), Class I & II, with DCI	HSTL_I_DCI, HSTL_II_DCI	50	0	V_{REF}	0.75
HSTL, Class III & IV, with DCI	HSTL_III_DCI, HSTL_IV_DCI	50	0	0.9	1.5
HSTL, Class I & II, 1.8V, with DCI	HSTL_I_DCI_18, HSTL_II_DCI_18	50	0	V_{REF}	0.9
HSTL, Class III & IV, 1.8V, with DCI	HSTL_III_DCI_18, HSTL_IV_DCI_18	50	0	1.1	1.8
SSTL (Stub Series Termi.Logic), Class I & II, 1.8V, with DCI	SSTL18_I_DCI, SSTL18_II_DCI	50	0	V_{REF}	0.9
SSTL, Class I & II, 2.5V, with DCI	SSTL2_I_DCI, SSTL2_II_DCI	50	0	V_{REF}	1.25
SSTL, Class I & II, 3.3V, with DCI	SSTL3_I_DCI, SSTL3_II_DCI	50	0	V_{REF}	1.5
GTL (Gunning Transceiver Logic) with DCI	GTL_DCI	50	0	0.8	1.2
GTL Plus with DCI	GTLP_DCI	50	0	1.0	1.5

Notes:
1. C_{REF} is the capacitance of the probe, nominally 0 pF.
2. Per PCI specifications.
3. Per PCI-X specifications.

Multiplier Switching Characteristics

Table 24: **Multiplier Switching Characteristics**

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Propagation Delay to Output Pin					
Input to Pin 35	T_{MULT_P35}	4.66	8.50	10.36	ns, Max
Input to Pin 34	T_{MULT_P34}	4.57	8.33	10.15	ns, Max
Input to Pin 33	T_{MULT_P33}	4.47	8.16	9.95	ns, Max
Input to Pin 32	T_{MULT_P32}	4.37	7.99	9.74	ns, Max
Input to Pin 31	T_{MULT_P31}	4.28	7.82	9.53	ns, Max
Input to Pin 30	T_{MULT_P30}	4.18	7.65	9.33	ns, Max
Input to Pin 29	T_{MULT_P29}	4.08	7.48	9.12	ns, Max
Input to Pin 28	T_{MULT_P28}	3.99	7.31	8.91	ns, Max
Input to Pin 27	T_{MULT_P27}	3.89	7.14	8.70	ns, Max
Input to Pin 26	T_{MULT_P26}	3.79	6.97	8.50	ns, Max
Input to Pin 25	T_{MULT_P25}	3.69	6.80	8.29	ns, Max
Input to Pin 24	T_{MULT_P24}	3.60	6.63	8.08	ns, Max
Input to Pin 23	T_{MULT_P23}	3.50	6.46	7.88	ns, Max
Input to Pin 22	T_{MULT_P22}	3.40	6.29	7.67	ns, Max
Input to Pin 21	T_{MULT_P21}	3.31	6.12	7.46	ns, Max
Input to Pin 20	T_{MULT_P20}	3.21	5.95	7.26	ns, Max
Input to Pin 19	T_{MULT_P19}	3.11	5.78	7.05	ns, Max
Input to Pin 18	T_{MULT_P18}	3.02	5.61	6.84	ns, Max
Input to Pin 17	T_{MULT_P17}	2.92	5.44	6.63	ns, Max
Input to Pin 16	T_{MULT_P16}	2.82	5.27	6.43	ns, Max
Input to Pin 15	T_{MULT_P15}	2.72	5.10	6.22	ns, Max
Input to Pin 14	T_{MULT_P14}	2.63	4.93	6.01	ns, Max
Input to Pin 13	T_{MULT_P13}	2.53	4.76	5.81	ns, Max
Input to Pin 12	T_{MULT_P12}	2.43	4.59	5.60	ns, Max
Input to Pin 11	T_{MULT_P11}	2.34	4.42	5.39	ns, Max
Input to Pin 10	T_{MULT_P10}	2.24	4.25	5.19	ns, Max
Input to Pin 9	T_{MULT_P9}	2.14	4.08	4.98	ns, Max
Input to Pin 8	T_{MULT_P8}	2.05	3.91	4.77	ns, Max
Input to Pin 7	T_{MULT_P7}	1.95	3.74	4.56	ns, Max
Input to Pin 6	T_{MULT_P6}	1.85	3.57	4.36	ns, Max
Input to Pin 5	T_{MULT_P5}	1.75	3.40	4.15	ns, Max
Input to Pin 4	T_{MULT_P4}	1.66	3.23	3.94	ns, Max
Input to Pin 3	T_{MULT_P3}	1.56	3.06	3.74	ns, Max
Input to Pin 2	T_{MULT_P2}	1.46	2.89	3.53	ns, Max
Input to Pin 1	T_{MULT_P1}	1.37	2.72	3.32	ns, Max
Input to Pin 0	T_{MULT_P0}	1.27	2.55	3.12	ns, Max

Virtex-II Pin-to-Pin Input Parameter Guidelines

All devices are 100% functionally tested. Listed below are representative values for typical pin locations and normal clock loading. Values are expressed in nanoseconds unless otherwise noted.

Global Clock Setup and Hold for LVTTL Standard, *With* DCM

Table 36: **Global Clock Setup and Hold for LVTTL Standard, *With* DCM**

Description	Symbol	Device	Speed Grade			Units
			-6	-5	-4	
Input Setup and Hold Time Relative to Global Clock Input Signal for LVTTL Standard. For data input with different standards, adjust the setup time delay by the values shown in IOB Input Switching Characteristics Standard Adjustments, page 11.						
No Delay Global Clock and IFF with DCM	T_{PSDCM}/T_{PHDCM}	XC2V40	1.60/–0.90	1.60/–0.90	1.84/–0.76	ns
		XC2V80	1.60/–0.90	1.60/–0.90	1.84/–0.76	ns
		XC2V250	1.60/–0.90	1.60/–0.90	1.84/–0.76	ns
		XC2V500	1.60/–0.90	1.60/–0.90	1.84/–0.76	ns
		XC2V1000	1.60/–0.90	1.60/–0.90	1.84/–0.76	ns
		XC2V1500	1.60/–0.90	1.60/–0.90	1.84/–0.76	ns
		XC2V2000	1.70/–0.90	1.70/–0.90	1.96/–0.76	ns
		XC2V3000	1.70/–0.90	1.70/–0.90	1.96/–0.76	ns
		XC2V4000	1.70/–0.90	1.70/–0.90	1.96/–0.76	ns
		XC2V6000	1.70/–0.90	1.70/–0.90	1.96/–0.76	ns
		XC2V8000		1.70/–0.90	1.96/–0.76	ns

Notes:
1. IFF = Input Flip-Flop or Latch
2. Setup time is measured relative to the Global Clock input signal with the fastest route and the lightest load. Hold time is measured relative to the Global Clock input signal with the slowest route and heaviest load.

Miscellaneous Timing Parameters

Table 42: **Miscellaneous Timing Parameters**

Description	Symbol	Constraints F_{CLKIN}	Speed Grade			Units
			-6	-5	-4	
Time Required to Achieve LOCK						
Using DLL outputs(1)	LOCK_DLL					
	LOCK_DLL_60	> 60MHz	20.0	20.0	20.0	µs
	LOCK_DLL_50_60	50 - 60 MHz	25.0	25.0	25.0	µs
	LOCK_DLL_40_50	40 - 50 MHz	50.0	50.0	50.0	µs
	LOCK_DLL_30_40	30 - 40 MHz	90.0	90.0	90.0	µs
	LOCK_DLL_24_30	24 - 30 MHz	120.0	120.0	120.0	µs
Using CLKFX outputs	LOCK_FX_MIN		10.0	10.0	10.0	ms
	LOCK_FX_MAX		10.0	10.0	10.0	ms
Additional lock time with fine-phase shifting	LOCK_DLL_FINE_SHIFT		50.0	50.0	50.0	µs
Fine-Phase Shifting						
Absolute shifting range	FINE_SHIFT_RANGE		10.0	10.0	10.0	ns
Delay Lines						
Tap delay resolution	DCM_TAP_MIN		30.0	30.0	30.0	ps
	DCM_TAP_MAX		60.0	60.0	60.0	ps

Notes:
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. Specification also applies to PSCLK.

Frequency Synthesis

Table 43: **Frequency Synthesis**

Attribute	Min	Max
CLKFX_MULTIPLY	2	32
CLKFX_DIVIDE	1	32

Parameter Cross Reference

Table 44: **Parameter Cross Reference**

Libraries Guide	Data Sheet
DLL_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_{1X|2X|DV}_LF
DFS_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_FX_LF
DLL_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_DLL_LF
DFS_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_FX_LF
DLL_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_{1X|DV}_HF
DFS_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_FX_HF
DLL_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_DLL_HF
DFS_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_FX_HF

Date	Version	Revision
07/30/01	1.6	• Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables. • Added values to the Virtex-II Pin-to-Pin Output Parameter Guidelines and Virtex-II Pin-to-Pin Input Parameter Guidelines tables. • Added Frequency Synthesis table.
10/02/01	1.7	• Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables. • Updated the speed grade designations used in data sheets, and added Table 13, which shows the current speed grade designation for each device.
10/05/01	1.8	• Corrected the speed grade designation for the XC2V1000 device in Table 13.
10/12/01	1.9	• Updated values in the Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables.
11/28/01	2.0	• Updated values in Table 3, Table 4, Table 5, Virtex-II Performance Characteristics, and Virtex-II Switching Characteristics tables.
01/03/02	2.1	• Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.96**. • Changed the speed grade designation for the XC2V6000 device in Table 13.
07/16/02	2.2	• Updated values in Table 4, "Quiescent Supply Current." • Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.111**. • Added Enhanced Multiplier Switching Characteristics section. • Added footnote to Table 37, "Global Clock Setup and Hold for LVTTL Standard, Without DCM." • Added Source-Synchronous Switching Characteristics section.
09/26/02	2.3	• Removed mention of MIL-M-38510/605 specification. • Added footnotes to Table 2 and Table 6.
12/06/02	2.4	• Revised SSTL2 values in Table 6 to match the latest JEDEC specification. • Added footnote regarding V_{IN} PCI compliance to Table 1. • Added footnote regarding CLKOUT_DUTY_CYCLE_DLL to Table 41.
05/07/03	2.5	• Updated values in Virtex-II Performance Characteristics and Virtex-II Switching Characteristics tables, based on values extracted from **speedsfile version 1.114**. • Table 4, Quiescent Supply Current, and Table 5, Minimum Power On Current Required for Virtex-II Devices: Added parameters for XC2V8000 device. • Table 16, IOB Output Switching Characteristics: Changed parameter designator T_{IOTON} to T_{IOTP}. • Table 26, Enhanced Multiplier Switching Characteristics: Corrected all parameter designators from $T_{MULT\_P[nn]}$ to $T_{MULT1\_P[nn]}$ in order to correspond with designators used in speedsfile. • Table 27, Enhanced Pipelined Multiplier Switching Characteristics: Corrected all parameter designators from $T_{MULTCK\_P[nn]}$ to $T_{MULTCK1\_P[nn]}$ in order to correspond with designators used in speedsfile. • Removed old Table 19, **Standard Capacitive Loads**. • Added Figure 1, page 17, showing test configuration for measuring I/O standard adjustments.
06/19/03	2.5.1	• Removed footnotes in Table 34 and Table 36 that stated DCM jitter was included in the measurements.

CS144/CSG144 Chip-Scale BGA Package

As shown in Table 5, XC2V40, XC2V80, and XC2V250 Virtex-II devices are available in the CS144/CSG144 package. Pins in the XC2V40, XC2V80, and XC2V250 devices are the same except for pin differences in the XC2V40 device, shown in the No Connect column. Following this table are the CS144/CSG144 Chip-Scale BGA Package Specifications (0.80mm pitch).

Table 5: **CS144/CSG144 — XC2V40, XC2V80, and XC2V250**

Bank	Pin Description	Pin Number	No Connect in the XC2V40
0	IO_L01N_0	B3	
0	IO_L01P_0	A3	
0	IO_L02N_0	C4	
0	IO_L02P_0	B4	
0	IO_L03N_0/VRP_0	A4	
0	IO_L03P_0/VRN_0	D5	
0	IO_L94N_0/VREF_0	A5	
0	IO_L94P_0	D6	
0	IO_L95N_0/GCLK7P	C6	
0	IO_L95P_0/GCLK6S	B6	
0	IO_L96N_0/GCLK5P	A6	
0	IO_L96P_0/GCLK4S	D7	
1	IO_L96N_1/GCLK3P	A7	
1	IO_L96P_1/GCLK2S	B7	
1	IO_L95N_1/GCLK1P	A8	
1	IO_L95P_1/GCLK0S	B8	
1	IO_L94N_1	C8	
1	IO_L94P_1/VREF_1	D8	
1	IO_L03N_1/VRP_1	C9	
1	IO_L03P_1/VRN_1	D9	
1	IO_L02N_1	A10	
1	IO_L02P_1	B10	
1	IO_L01N_1	C10	
1	IO_L01P_1	D10	
2	IO_L01N_2	C13	
2	IO_L01P_2	D11	
2	IO_L02N_2/VRP_2	D12	
2	IO_L02P_2/VRN_2	D13	
2	IO_L03N_2	E10	
2	IO_L03P_2/VREF_2	E11	
2	IO_L93N_2	E13	NC
2	IO_L93P_2/VREF_2	F11	NC
2	IO_L94N_2	F12	
2	IO_L94P_2	G10	

Table 7: **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
7	IO_L51N_7	J2	NC	
7	IO_L49P_7	J3	NC	
7	IO_L49N_7	J4	NC	
7	IO_L48P_7	H1		
7	IO_L48N_7	H2		
7	IO_L46P_7	H3		
7	IO_L46N_7	H4		
7	IO_L45P_7/VREF_7	J6		
7	IO_L45N_7	H5		
7	IO_L43P_7	G1		
7	IO_L43N_7	G2		
7	IO_L24P_7	G3	NC	NC
7	IO_L24N_7	G4	NC	NC
7	IO_L22P_7	F1	NC	NC
7	IO_L22N_7	F2	NC	NC
7	IO_L21P_7/VREF_7	F3	NC	NC
7	IO_L21N_7	F4	NC	NC
7	IO_L19P_7	G5	NC	NC
7	IO_L19N_7	F5	NC	NC
7	IO_L06P_7	E1		
7	IO_L06N_7	E2		
7	IO_L04P_7	E3		
7	IO_L04N_7	E4		
7	IO_L03P_7/VREF_7	D1		
7	IO_L03N_7	D2		
7	IO_L02P_7/VRN_7	C1		
7	IO_L02N_7/VRP_7	C2		
7	IO_L01P_7	E5		
7	IO_L01N_7	E6		
0	VCCO_0	G11		
0	VCCO_0	G10		
0	VCCO_0	G9		
0	VCCO_0	F8		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
7	IO_L21P_7/VREF_7	F3		
7	IO_L21N_7	F2		
7	IO_L19P_7	H6		
7	IO_L19N_7	H7		
7	IO_L06P_7	E1		
7	IO_L06N_7	E2		
7	IO_L04P_7	D1		
7	IO_L04N_7	D2		
7	IO_L03P_7/VREF_7	C1		
7	IO_L03N_7	C2		
7	IO_L02P_7/VRN_7	E3		
7	IO_L02N_7/VRP_7	E4		
7	IO_L01P_7	G5		
7	IO_L01N_7	F4		
0	VCCO_0	J13		
0	VCCO_0	J12		
0	VCCO_0	J11		
0	VCCO_0	H10		
0	VCCO_0	H9		
0	VCCO_0	B10		
0	VCCO_0	B7		
1	VCCO_1	B17		
1	VCCO_1	J16		
1	VCCO_1	J15		
1	VCCO_1	J14		
1	VCCO_1	H18		
1	VCCO_1	H17		
1	VCCO_1	B20		
2	VCCO_2	N18		
2	VCCO_2	M18		
2	VCCO_2	L18		
2	VCCO_2	K25		
2	VCCO_2	K19		
2	VCCO_2	J19		
2	VCCO_2	G25		
3	VCCO_3	Y25		

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L69P_0/VREF_0	B9	NC	
0	IO_L70N_0	F10	NC	
0	IO_L70P_0	E10	NC	
0	IO_L72N_0	A10	NC	
0	IO_L72P_0	A11	NC	
0	IO_L73N_0	C10	NC	NC
0	IO_L73P_0	B10	NC	NC
0	IO_L91N_0/VREF_0	D11		
0	IO_L91P_0	C11		
0	IO_L92N_0	G11		
0	IO_L92P_0	E11		
0	IO_L93N_0	C12		
0	IO_L93P_0	B12		
0	IO_L94N_0/VREF_0	E12		
0	IO_L94P_0	D12		
0	IO_L95N_0/GCLK7P	G12		
0	IO_L95P_0/GCLK6S	F12		
0	IO_L96N_0/GCLK5P	H11		
0	IO_L96P_0/GCLK4S	H12		
1	IO_L96N_1/GCLK3P	A13		
1	IO_L96P_1/GCLK2S	A14		
1	IO_L95N_1/GCLK1P	B13		
1	IO_L95P_1/GCLK0S	C13		
1	IO_L94N_1	D13		
1	IO_L94P_1/VREF_1	E13		
1	IO_L93N_1	F13		
1	IO_L93P_1	G13		
1	IO_L92N_1	H13		
1	IO_L92P_1	H14		
1	IO_L91N_1	C14		
1	IO_L91P_1/VREF_1	D14		
1	IO_L73N_1	E14	NC	NC
1	IO_L73P_1	G14	NC	NC
1	IO_L72N_1	A15	NC	
1	IO_L72P_1	A16	NC	

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
7	IO_L46P_7	H2		
7	IO_L46N_7	G2		
7	IO_L45P_7/VREF_7	H3		
7	IO_L45N_7	H4		
7	IO_L43P_7	G3		
7	IO_L43N_7	G4		
7	IO_L24P_7	H5		
7	IO_L24N_7	H6		
7	IO_L22P_7	J6		
7	IO_L22N_7	J7		
7	IO_L21P_7/VREF_7	K7		
7	IO_L21N_7	K8		
7	IO_L19P_7	E1		
7	IO_L19N_7	E2		
7	IO_L06P_7	D2		
7	IO_L06N_7	D3		
7	IO_L04P_7	E3		
7	IO_L04N_7	E4		
7	IO_L03P_7/VREF_7	F4		
7	IO_L03N_7	F5		
7	IO_L02P_7/VRN_7	G5		
7	IO_L02N_7/VRP_7	G6		
7	IO_L01P_7	H7		
7	IO_L01N_7	J8		
0	VCCO_0	J12		
0	VCCO_0	J11		
0	VCCO_0	J10		
0	VCCO_0	F11		
0	VCCO_0	C6		
0	VCCO_0	B11		
1	VCCO_1	J15		
1	VCCO_1	J14		
1	VCCO_1	J13		
1	VCCO_1	F14		
1	VCCO_1	C19		

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
3	IO_L72N_3	T20
3	IO_L72P_3	T19
3	IO_L70N_3	U27
3	IO_L70P_3	U26
3	IO_L69N_3/VREF_3	U25
3	IO_L69P_3	V25
3	IO_L67N_3	U21
3	IO_L67P_3	U20
3	IO_L54N_3	V27
3	IO_L54P_3	V26
3	IO_L52N_3	V24
3	IO_L52P_3	V23
3	IO_L51N_3/VREF_3	V22
3	IO_L51P_3	W22
3	IO_L49N_3	V21
3	IO_L49P_3	V20
3	IO_L48N_3	W27
3	IO_L48P_3	Y27
3	IO_L46N_3	W26
3	IO_L46P_3	W25
3	IO_L45N_3/VREF_3	W24
3	IO_L45P_3	W23
3	IO_L43N_3	W21
3	IO_L43P_3	W20
3	IO_L28N_3	W19
3	IO_L28P_3	Y19
3	IO_L27N_3/VREF_3	Y25
3	IO_L27P_3	Y24
3	IO_L25N_3	Y23
3	IO_L25P_3	AA23
3	IO_L24N_3	Y22
3	IO_L24P_3	Y21
3	IO_L22N_3	AA27
3	IO_L22P_3	AB27
3	IO_L21N_3/VREF_3	AA26
3	IO_L21P_3	AA25

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
7	IO_L27P_7/VREF_7	H5
7	IO_L27N_7	H6
7	IO_L25P_7	J7
7	IO_L25N_7	J8
7	IO_L24P_7	G1
7	IO_L24N_7	F1
7	IO_L22P_7	G2
7	IO_L22N_7	G3
7	IO_L21P_7/VREF_7	F2
7	IO_L21N_7	F3
7	IO_L19P_7	G5
7	IO_L19N_7	G6
7	IO_L06P_7	F4
7	IO_L06N_7	F5
7	IO_L04P_7	E1
7	IO_L04N_7	E2
7	IO_L03P_7/VREF_7	D1
7	IO_L03N_7	C1
7	IO_L02P_7/VRN_7	E3
7	IO_L02N_7/VRP_7	E4
7	IO_L01P_7	D2
7	IO_L01N_7	D3
0	VCCO_0	K13
0	VCCO_0	K12
0	VCCO_0	K11
0	VCCO_0	J11
0	VCCO_0	J10
0	VCCO_0	G12
0	VCCO_0	D7
0	VCCO_0	C12
1	VCCO_1	K17
1	VCCO_1	K16
1	VCCO_1	K15
1	VCCO_1	J18
1	VCCO_1	J17

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
NA	GND	T12
NA	GND	R16
NA	GND	R15
NA	GND	R14
NA	GND	R13
NA	GND	R12
NA	GND	P27
NA	GND	P24
NA	GND	P19
NA	GND	P16
NA	GND	P15
NA	GND	P14
NA	GND	P13
NA	GND	P12
NA	GND	P9
NA	GND	P4
NA	GND	P1
NA	GND	N16
NA	GND	N15
NA	GND	N14
NA	GND	N13
NA	GND	N12
NA	GND	M16
NA	GND	M15
NA	GND	M14
NA	GND	M13
NA	GND	M12
NA	GND	L23
NA	GND	L5
NA	GND	J14
NA	GND	H26
NA	GND	H20
NA	GND	H8
NA	GND	H2
NA	GND	G21
NA	GND	G7

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
0	IO_L77N_0	J20	
0	IO_L77P_0	K19	
0	IO_L78N_0	D20	
0	IO_L78P_0	D21	
0	IO_L79N_0	A21	NC
0	IO_L79P_0	A22	NC
0	IO_L80N_0	L19	NC
0	IO_L80P_0	L18	NC
0	IO_L81N_0	B19	NC
0	IO_L81P_0/VREF_0	A20	NC
0	IO_L82N_0	A18	NC
0	IO_L82P_0	B18	NC
0	IO_L83N_0	H19	NC
0	IO_L83P_0	H18	NC
0	IO_L84N_0	C20	NC
0	IO_L84P_0	C21	NC
0	IO_L91N_0/VREF_0	D19	
0	IO_L91P_0	D18	
0	IO_L92N_0	G18	
0	IO_L92P_0	G19	
0	IO_L93N_0	F18	
0	IO_L93P_0	F19	
0	IO_L94N_0/VREF_0	C19	
0	IO_L94P_0	C18	
0	IO_L95N_0/GCLK7P	K18	
0	IO_L95P_0/GCLK6S	J18	
0	IO_L96N_0/GCLK5P	E19	
0	IO_L96P_0/GCLK4S	E18	
1	IO_L96N_1/GCLK3P	E17	
1	IO_L96P_1/GCLK2S	E16	
1	IO_L95N_1/GCLK1P	H17	
1	IO_L95P_1/GCLK0S	H16	
1	IO_L94N_1	D17	
1	IO_L94P_1/VREF_1	D16	
1	IO_L93N_1	F16	

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
5	IO_L79P_5	AP21	NC
5	IO_L78N_5	AK22	
5	IO_L78P_5	AK21	
5	IO_L77N_5	AD18	
5	IO_L77P_5	AD19	
5	IO_L76N_5	AN22	
5	IO_L76P_5	AN21	
5	IO_L75N_5/VREF_5	AJ20	
5	IO_L75P_5	AH20	
5	IO_L74N_5	AG19	
5	IO_L74P_5	AG20	
5	IO_L73N_5	AP24	
5	IO_L73P_5	AP23	
5	IO_L72N_5	AL23	
5	IO_L72P_5	AL22	
5	IO_L71N_5	AF20	
5	IO_L71P_5	AF21	
5	IO_L70N_5	AM24	
5	IO_L70P_5	AM23	
5	IO_L69N_5/VREF_5	AJ21	
5	IO_L69P_5	AJ22	
5	IO_L68N_5	AJ24	
5	IO_L68P_5	AJ23	
5	IO_L67N_5	AN24	
5	IO_L67P_5	AN23	
5	IO_L60N_5	AN26	NC
5	IO_L60P_5	AN25	NC
5	IO_L54N_5	AL25	
5	IO_L54P_5	AL24	
5	IO_L53N_5	AE20	
5	IO_L53P_5	AE21	
5	IO_L52N_5	AN27	
5	IO_L52P_5	AP26	
5	IO_L51N_5/VREF_5	AP29	
5	IO_L51P_5	AP28	
5	IO_L50N_5	AG21	

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	AP33	
NA	GND	AP32	
NA	GND	AP27	
NA	GND	AP8	
NA	GND	AP3	
NA	GND	AP2	
NA	GND	AN34	
NA	GND	AN33	
NA	GND	AN20	
NA	GND	AN15	
NA	GND	AN2	
NA	GND	AN1	
NA	GND	AM34	
NA	GND	AM32	
NA	GND	AM25	
NA	GND	AM10	
NA	GND	AM3	
NA	GND	AM1	
NA	GND	AL31	
NA	GND	AL4	
NA	GND	AK30	
NA	GND	AK23	
NA	GND	AK12	
NA	GND	AK5	
NA	GND	AJ29	
NA	GND	AJ6	
NA	GND	AH28	
NA	GND	AH21	
NA	GND	AH14	
NA	GND	AH7	
NA	GND	AG34	
NA	GND	AG27	
NA	GND	AG8	
NA	GND	AG1	
NA	GND	AF19	
NA	GND	AF16	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
7	IO_L50P_7	P32		
7	IO_L50N_7	N32		
7	IO_L49P_7	L37		
7	IO_L49N_7	M37		
7	IO_L48P_7	N34		
7	IO_L48N_7	P34		
7	IO_L47P_7	P31		
7	IO_L47N_7	N31		
7	IO_L46P_7	M35		
7	IO_L46N_7	N35		
7	IO_L45P_7/VREF_7	L36		
7	IO_L45N_7	M36		
7	IO_L44P_7	R28		
7	IO_L44N_7	P28		
7	IO_L43P_7	K39		
7	IO_L43N_7	L39		
7	IO_L36P_7	L34	NC	
7	IO_L36N_7	M34	NC	
7	IO_L35P_7	P29	NC	
7	IO_L35N_7	N29	NC	
7	IO_L34P_7	J38	NC	
7	IO_L34N_7	K38	NC	
7	IO_L33P_7/VREF_7	L33	NC	
7	IO_L33N_7	M33	NC	
7	IO_L32P_7	M32	NC	
7	IO_L32N_7	L32	NC	
7	IO_L31P_7	H39	NC	
7	IO_L31N_7	J39	NC	
7	IO_L30P_7	J36		
7	IO_L30N_7	K36		
7	IO_L29P_7	N30		
7	IO_L29N_7	M30		
7	IO_L28P_7	J37		
7	IO_L28N_7	K37		
7	IO_L27P_7/VREF_7	J35		
7	IO_L27N_7	K35		